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Understanding **Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	896
Number of Logic Elements/Cells	8064
Total RAM Bits	294912
Number of I/O	97
Number of Gates	400000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s400-5tqg144c

In contrast, the 144-pin Thin Quad Flat Pack (TQ144) package and the 132-pin Chip-Scale Package (CP132) tie V_{CCO} together internally for the pair of banks on each side of the device. For example, the V_{CCO} Bank 0 and the V_{CCO} Bank 1 lines are tied together. The interconnected bank-pairs are 0/1, 2/3, 4/5, and 6/7. As a result, Spartan-3 devices in the CP132 and TQ144 packages support four independent V_{CCO} supplies.

Note: The CP132 package is discontinued. See http://www.xilinx.com/support/documentation/spartan-3_customer_notices.htm.

Spartan-3 FPGA Compatibility

Within the Spartan-3 family, all devices are pin-compatible by package. When the need for future logic resources outgrows the capacity of the Spartan-3 device in current use, a larger device in the same package can serve as a direct replacement. Larger devices may add extra V_{REF} and V_{CCO} lines to support a greater number of I/Os. In the larger device, more pins can convert from user I/Os to V_{REF} lines. Also, additional V_{CCO} lines are bonded out to pins that were “not connected” in the smaller device. Thus, it is important to plan for future upgrades at the time of the board’s initial design by laying out connections to the extra pins.

The Spartan-3 family is not pin-compatible with any previous Xilinx FPGA family or with other platforms among the Spartan-3 Generation FPGAs.

Rules Concerning Banks

When assigning I/Os to banks, it is important to follow the following V_{CCO} rules:

- Leave no V_{CCO} pins unconnected on the FPGA.
- Set all V_{CCO} lines associated with the (interconnected) bank to the same voltage level.
- The V_{CCO} levels used by all standards assigned to the I/Os of the (interconnected) bank(s) must agree. The Xilinx development software checks for this. Tables 8, 9, and 10 describe how different standards use the V_{CCO} supply.
- Only one of the following standards is allowed on outputs per bank: LVDS, LDT, LVDS_EXT, or RSDS. This restriction is for the eight banks in each device, even if the V_{CCO} levels are shared across banks, as in the CP132 and TQ144 packages.
- If none of the standards assigned to the I/Os of the (interconnected) bank(s) uses V_{CCO} , tie all associated V_{CCO} lines to 2.5V.
- In general, apply 2.5V to V_{CCO} Bank 4 from power-on to the end of configuration. Apply the same voltage to V_{CCO} Bank 5 during parallel configuration or a Readback operation. For information on how to program the FPGA using 3.3V signals and power, see the [3.3V-Tolerant Configuration Interface](#) section.

If any of the standards assigned to the Inputs of the bank use V_{REF} then observe the following additional rules:

- Connect *all* V_{REF} pins within the bank to the same voltage level.
- The V_{REF} levels used by all standards assigned to the Inputs of the bank must agree. The Xilinx development software checks for this. Tables 8 and 10 describe how different standards use the V_{REF} supply.

If none of the standards assigned to the Inputs of a bank use V_{REF} for biasing input switching thresholds, all associated V_{REF} pins function as User I/Os.

Exceptions to Banks Supporting I/O Standards

Bank 5 of any Spartan-3 device in a VQ100, CP132, or TQ144 package does not support DCI signal standards. In this case, bank 5 has neither VRN nor VRP pins.

Furthermore, banks 4 and 5 of any Spartan-3 device in a VQ100 package do not support signal standards using V_{REF} (see [Table 8](#)). In this case, the two banks do not have any V_{REF} pins.

Coarse Phase Shift Outputs of the DLL Component

In addition to CLK0 for zero-phase alignment to the CLKIN signal, the DLL also provides the CLK90, CLK180 and CLK270 outputs for 90°, 180° and 270° phase-shifted signals, respectively. These signals are described in [Table 16, page 33](#). Their relative timing in the Low Frequency Mode is shown in [Figure 22, page 37](#). The CLK90, CLK180 and CLK270 outputs are not available when operating in the High Frequency mode. (See the description of the DLL_FREQUENCY_MODE attribute in [Table 17, page 33](#).) For control in finer increments than 90°, see [Phase Shifter \(PS\), page 39](#).

Basic Frequency Synthesis Outputs of the DLL Component

The DLL component provides basic options for frequency multiplication and division in addition to the more flexible synthesis capability of the DFS component, described in a later section. These operations result in output clock signals with frequencies that are either a fraction (for division) or a multiple (for multiplication) of the incoming clock frequency. The CLK2X output produces an in-phase signal that is twice the frequency of CLKIN. The CLK2X180 output also doubles the frequency, but is 180° out-of-phase with respect to CLKIN. The CLKDIV output generates a clock frequency that is a predetermined fraction of the CLKIN frequency. The CLKDV_DIVIDE attribute determines the factor used to divide the CLKIN frequency. The attribute can be set to various values as described in [Table 17](#). The basic frequency synthesis outputs are described in [Table 16](#). Their relative timing in the Low Frequency Mode is shown in [Figure 22](#).

The CLK2X and CLK2X180 outputs are not available when operating in the High Frequency mode. See the description of the DLL_FREQUENCY_MODE attribute in [Table 18](#).

Duty Cycle Correction of DLL Clock Outputs

The CLK2X⁽¹⁾, CLK2X180, and CLKDV⁽²⁾ output signals ordinarily exhibit a 50% duty cycle—even if the incoming CLKIN signal has a different duty cycle. A 50% duty cycle means that the High and Low times of each clock cycle are equal. The DUTY_CYCLE_CORRECTION attribute determines whether or not duty cycle correction is applied to the CLK0, CLK90, CLK180 and CLK270 outputs. If DUTY_CYCLE_CORRECTION is set to TRUE, then the duty cycle of these four outputs is corrected to 50%. If DUTY_CYCLE_CORRECTION is set to FALSE, then these outputs exhibit the same duty cycle as the CLKIN signal. [Figure 22](#) compares the characteristics of the DLL's output signals to those of the CLKIN signal.

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1. The CLK2X output generates a 25% duty cycle clock at the same frequency as the CLKIN signal until the DLL has achieved lock.
 2. The duty cycle of the CLKDV outputs may differ somewhat from 50% (i.e., the signal will be High for less than 50% of the period) when the CLKDV_DIVIDE attribute is set to a non-integer value *and* the DLL is operating in the High Frequency mode.

The 1% precision impedance-matching resistor attached to the VRN_# pin controls the pull-down impedance of NMOS transistor in the input or output buffer. Consequently, the VRN_# pin must connect to VCCO. The ‘N’ character in “VRN” indicates that this pin controls the I/O buffer’s NMOS transistor impedance. The VRN_# pin is only used for split termination.

Each VRN or VRP reference input requires its own resistor. A single resistor cannot be shared between VRN or VRP pins associated with different banks.

During configuration, these pins behave exactly like user-I/O pins. The associated DCI behavior is not active or valid until after configuration completes.

Also see [Digitally Controlled Impedance \(DCI\), page 16](#).

DCI Termination Types

If the I/O in an I/O bank do not use the DCI feature, then no external resistors are required and both the VRP_# and VRN_# pins are available for user I/O, as shown in section [a] of [Figure 42](#).

If the I/O standards within the associated I/O bank require single termination—such as GTL_DCI, GTLP_DCI, or HSTL_III_DCI—then only the VRP_# signal connects to a 1% precision impedance-matching resistor, as shown in section [b] of [Figure 42](#). A resistor is not required for the VRN_# pin.

Finally, if the I/O standards with the associated I/O bank require split termination—such as HSTL_I_DCI, SSSL2_I_DCI, SSSL2_II_DCI, or LVDS_25_DCI and LVDSEXT_25_DCI receivers—then both the VRP_# and VRN_# pins connect to separate 1% precision impedance-matching resistors, as shown in section [c] of [Figure 42](#). Neither pin is available for user I/O.

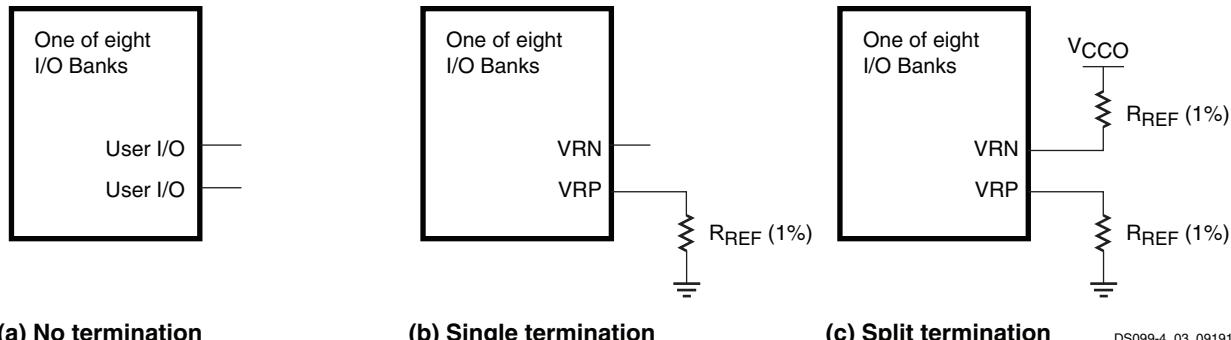


Figure 42: DCI Termination Types

DS099-4_03_091910

GCLK: Global Clock Buffer Inputs or General-Purpose I/O Pins

These pins are user-I/O pins unless they specifically connect to one of the eight low-skew global clock buffers on the device, specified using the IBUFG primitive.

There are eight GCLK pins per device and two each appear in the top-edge banks, Bank 0 and 1, and the bottom-edge banks, Banks 4 and 5. See [Figure 40](#) for a picture of bank labeling.

During configuration, these pins behave exactly like user-I/O pins.

Also see [Global Clock Network, page 42](#).

CONFIG: Dedicated Configuration Pins

The dedicated configuration pins control the configuration process and are not available as user-I/O pins. Every package has seven dedicated configuration pins. All CONFIG-type pins are powered by the +2.5V VCCAUX supply.

Also see [Configuration, page 46](#).

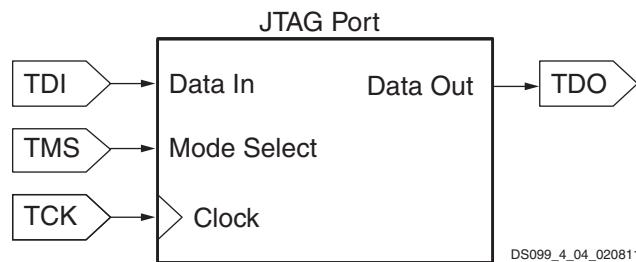


Figure 43: JTAG Port

IDCODE Register

Spartan-3 FPGAs contain a 32-bit identification register called the IDCODE register, as defined in the IEEE 1149.1 JTAG standard. The fixed value electrically identifies the manufacturer (Xilinx) and the type of device being addressed over a JTAG chain. This register allows the JTAG host to identify the device being tested or programmed via JTAG. See [Table 78](#).

Using JTAG Port After Configuration

The JTAG port is always active and available before, during, and after FPGA configuration. Add the BSCAN_SPARTAN3 primitive to the design to create user-defined JTAG instructions and JTAG chains to communicate with internal logic.

Furthermore, the contents of the User ID register within the JTAG port can be specified as a Bitstream Generation option. By default, the 32-bit User ID register contains 0xFFFFFFFF.

Table 78: Spartan-3 JTAG IDCODE Register Values (hexadecimal)

Part Number	IDCODE Register
XC3S50	0x0140C093
XC3S200	0x01414093
XC3S400	0x0141C093
XC3S1000	0x01428093
XC3S1500	0x01434093
XC3S2000	0x01440093
XC3S4000	0x01448093
XC3S5000	0x01450093

Precautions When Using the JTAG Port in 3.3V Environments

The JTAG port is powered by the +2.5V VCCAUX power supply. When connecting to a 3.3V interface, the JTAG input pins must be current-limited using a series resistor. Similarly, the TDO pin is a CMOS output powered from +2.5V. The TDO output can directly drive a 3.3V input but with reduced noise immunity. See [3.3V-Tolerant Configuration Interface, page 47](#). See also [XAPP453: The 3.3V Configuration of Spartan-3 FPGAs](#) for additional details.

The following interface precautions are recommended when connecting the JTAG port to a 3.3V interface.

- Avoid actively driving the JTAG input signals High with 3.3V signal levels. If required in the application, use series current-limiting resistors to keep the current below 10 mA per pin.
- If possible, drive the FPGA JTAG inputs with drivers that can be placed in high-impedance (Hi-Z) after using the JTAG port. Alternatively, drive the FPGA JTAG inputs with open-drain outputs, which only drive Low. In both cases, pull-up resistors are required. The FPGA JTAG pins have pull-up resistors to VCCAUX before configuration and optional pull-up resistors after configuration, controlled by [Bitstream Options, page 125](#).

Package Thermal Characteristics

The power dissipated by an FPGA application has implications on package selection and system design. The power consumed by a Spartan-3 FPGA is reported using either the [XPower Estimator \(XPE\)](#) or the [XPower Analyzer](#) integrated in the Xilinx ISE development software. [Table 86](#) provides the thermal characteristics for the various Spartan-3 device/package offerings.

The junction-to-case thermal resistance (θ_{JC}) indicates the difference between the temperature measured on the package body (case) and the die junction temperature per watt of power consumption. The junction-to-board (θ_{JB}) value similarly reports the difference between the board and junction temperature. The junction-to-ambient (θ_{JA}) value reports the temperature difference per watt between the ambient environment and the junction temperature. The θ_{JA} value is reported at different air velocities, measured in linear feet per minute (LFM). The “Still Air (0 LFM)” column shows the θ_{JA} value in a system without a fan. The thermal resistance drops with increasing air flow.

Table 86: Spartan-3 FPGA Package Thermal Characteristics

Package	Device	Junction-to-Case (θ_{JC})	Junction-to-Board (θ_{JB})	Junction-to-Ambient (θ_{JA}) at Different Air Flows				Units
				Still Air (0 LFM)	250 LFM	500 LFM	750 LFM	
VQ(G)100	XC3S50	12.0	–	46.2	38.4	35.8	34.9	°C/Watt
	XC3S200	10.0	–	40.5	33.7	31.3	30.5	°C/Watt
CP(G)132 ⁽¹⁾	XC3S50	14.5	32.8	53.0	46.4	44.0	42.5	°C/Watt
TQ(G)144	XC3S50	7.6	–	41.0	31.9	27.2	25.6	°C/Watt
	XC3S200	6.6	–	34.5	26.9	23.0	21.6	°C/Watt
	XC3S400	6.1	–	32.8	25.5	21.8	20.4	°C/Watt
PQ(G)208	XC3S50	10.6	–	37.4	27.6	24.4	22.6	°C/Watt
	XC3S200	8.6	–	36.2	26.7	23.6	21.9	°C/Watt
	XC3S400	7.5	–	35.4	26.1	23.1	21.4	°C/Watt
FT(G)256	XC3S200	9.9	22.9	31.7	25.6	24.5	24.2	°C/Watt
	XC3S400	7.9	19.0	28.4	22.8	21.5	21.0	°C/Watt
	XC3S1000	5.6	14.7	24.8	19.2	18.0	17.5	°C/Watt
FG(G)320	XC3S400	8.9	13.9	24.4	19.0	17.8	17.0	°C/Watt
	XC3S1000	7.8	11.8	22.3	17.0	15.8	15.0	°C/Watt
	XC3S1500	6.7	9.8	20.3	15.18	13.8	13.1	°C/Watt
FG(G)456	XC3S400	8.4	13.6	20.8	15.1	13.9	13.4	°C/Watt
	XC3S1000	6.4	10.6	19.3	13.4	12.3	11.7	°C/Watt
	XC3S1500	4.9	8.3	18.3	12.4	11.2	10.7	°C/Watt
	XC3S2000	3.7	6.5	17.7	11.7	10.5	10.0	°C/Watt
FG(G)676	XC3S1000	6.0	10.4	17.9	13.7	12.6	12.0	°C/Watt
	XC3S1500	4.9	8.8	16.8	12.4	11.3	10.7	°C/Watt
	XC3S2000	4.1	7.9	15.6	11.1	9.9	9.3	°C/Watt
	XC3S4000	3.6	7.0	15.0	10.5	9.3	8.7	°C/Watt
	XC3S5000	3.4	6.3	14.7	10.3	9.1	8.5	°C/Watt
FG(G)900	XC3S2000	3.7	7.0	14.3	10.3	9.3	8.8	°C/Watt
	XC3S4000	3.3	6.4	13.6	9.7	8.7	8.2	°C/Watt
	XC3S5000	2.9	5.9	13.1	9.2	8.1	7.6	°C/Watt

TQ144: 144-lead Thin Quad Flat Package

The XC3S50, the XC3S200, and the XC3S400 are available in the 144-lead thin quad flat package, TQ144. All devices share a common footprint for this package as shown in [Table 91](#) and [Figure 46](#).

The TQ144 package only has four separate VCCO inputs, unlike the BGA packages, which have eight separate VCCO inputs. The TQ144 package has a separate VCCO input for the top, bottom, left, and right. However, there are still eight separate I/O banks, as shown in [Table 91](#) and [Figure 46](#). Banks 0 and 1 share the VCCO_TOP input, Banks 2 and 3 share the VCCO_RIGHT input, Banks 4 and 5 share the VCCO_BOTTOM input, and Banks 6 and 7 share the VCCO_LEFT input.

All the package pins appear in [Table 91](#) and are sorted by bank number, then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at http://www.xilinx.com/support/documentation/data_sheets/s3_pin.zip.

Pinout Table

Table 91: TQ144 Package Pinout

Bank	XC3S50, XC3S200, XC3S400 Pin Name	TQ144 Pin Number	Type
0	IO_L01N_0/VRP_0	P141	DCI
0	IO_L01P_0/VRN_0	P140	DCI
0	IO_L27N_0	P137	I/O
0	IO_L27P_0	P135	I/O
0	IO_L30N_0	P132	I/O
0	IO_L30P_0	P131	I/O
0	IO_L31N_0	P130	I/O
0	IO_L31P_0/VREF_0	P129	VREF
0	IO_L32N_0/GCLK7	P128	GCLK
0	IO_L32P_0/GCLK6	P127	GCLK
1	IO	P116	I/O
1	IO_L01N_1/VRP_1	P113	DCI
1	IO_L01P_1/VRN_1	P112	DCI
1	IO_L28N_1	P119	I/O
1	IO_L28P_1	P118	I/O
1	IO_L31N_1/VREF_1	P123	VREF
1	IO_L31P_1	P122	I/O
1	IO_L32N_1/GCLK5	P125	GCLK
1	IO_L32P_1/GCLK4	P124	GCLK
2	IO_L01N_2/VRP_2	P108	DCI
2	IO_L01P_2/VRN_2	P107	DCI
2	IO_L20N_2	P105	I/O
2	IO_L20P_2	P104	I/O
2	IO_L21N_2	P103	I/O
2	IO_L21P_2	P102	I/O
2	IO_L22N_2	P100	I/O
2	IO_L22P_2	P99	I/O

Table 96: FT256 Package Pinout (Cont'd)

Bank	XC3S200, XC3S400, XC3S1000 Pin Name	FT256 Pin Number	Type
7	IO_L24P_7	G4	I/O
7	IO_L39N_7	H3	I/O
7	IO_L39P_7	H4	I/O
7	IO_L40N_7/VREF_7	H1	VREF
7	IO_L40P_7	G1	I/O
7	VCCO_7	G6	VCCO
7	VCCO_7	H5	VCCO
7	VCCO_7	H6	VCCO
N/A	GND	A1	GND
N/A	GND	A16	GND
N/A	GND	B2	GND
N/A	GND	B9	GND
N/A	GND	B15	GND
N/A	GND	F6	GND
N/A	GND	F11	GND
N/A	GND	G7	GND
N/A	GND	G8	GND
N/A	GND	G9	GND
N/A	GND	G10	GND
N/A	GND	H2	GND
N/A	GND	H7	GND
N/A	GND	H8	GND
N/A	GND	H9	GND
N/A	GND	H10	GND
N/A	GND	J7	GND
N/A	GND	J8	GND
N/A	GND	J9	GND
N/A	GND	J10	GND
N/A	GND	J15	GND
N/A	GND	K7	GND
N/A	GND	K8	GND
N/A	GND	K9	GND
N/A	GND	K10	GND
N/A	GND	L6	GND
N/A	GND	L11	GND
N/A	GND	R2	GND
N/A	GND	R8	GND
N/A	GND	R15	GND
N/A	GND	T1	GND

Table 98: FG320 Package Pinout (*Cont'd*)

Bank	XC3S400, XC3S1000, XC3S1500 Pin Name	FG320 Pin Number	Type
4	IO_L31P_4/ DOUT/BUSY	V10	DUAL
4	IO_L32N_4/GCLK1	N10	GCLK
4	IO_L32P_4/GCLK0	P10	GCLK
4	VCCO_4	M10	VCCO
4	VCCO_4	M11	VCCO
4	VCCO_4	T13	VCCO
4	VCCO_4	U11	VCCO
5	IO	N8	I/O
5	IO	P8	I/O
5	IO	U6	I/O
5	IO/VREF_5	R9	VREF
5	IO_L01N_5/RDWR_B	V3	DUAL
5	IO_L01P_5/CS_B	V2	DUAL
5	IO_L06N_5	T5	I/O
5	IO_L06P_5	T4	I/O
5	IO_L10N_5/VRP_5	V4	DCI
5	IO_L10P_5/VRN_5	U4	DCI
5	IO_L15N_5	R6	I/O
5	IO_L15P_5	R5	I/O
5	IO_L16N_5	V5	I/O
5	IO_L16P_5	U5	I/O
5	IO_L27N_5/VREF_5	P6	VREF
5	IO_L27P_5	P7	I/O
5	IO_L28N_5/D6	R7	DUAL
5	IO_L28P_5/D7	T7	DUAL
5	IO_L29N_5	V8	I/O
5	IO_L29P_5/VREF_5	V7	VREF
5	IO_L30N_5	R8	I/O
5	IO_L30P_5	T8	I/O
5	IO_L31N_5/D4	U9	DUAL
5	IO_L31P_5/D5	V9	DUAL
5	IO_L32N_5/GCLK3	N9	GCLK
5	IO_L32P_5/GCLK2	P9	GCLK
5	VCCO_5	M8	VCCO
5	VCCO_5	M9	VCCO
5	VCCO_5	T6	VCCO
5	VCCO_5	U8	VCCO
6	IO	K6	I/O
6	IO_L01N_6/VRP_6	T3	DCI

Table 100: FG456 Package Pinout (Cont'd)

Bank	3S400 Pin Name	3S1000, 3S1500, 3S2000 Pin Name	FG456 Pin Number	Type
3	IO_L16P_3	IO_L16P_3	Y22	I/O
3	IO_L17N_3	IO_L17N_3	V19	I/O
3	IO_L17P_3/VREF_3	IO_L17P_3/VREF_3	W19	VREF
3	IO_L19N_3	IO_L19N_3	W21	I/O
3	IO_L19P_3	IO_L19P_3	W20	I/O
3	IO_L20N_3	IO_L20N_3	U19	I/O
3	IO_L20P_3	IO_L20P_3	V20	I/O
3	IO_L21N_3	IO_L21N_3	V22	I/O
3	IO_L21P_3	IO_L21P_3	V21	I/O
3	IO_L22N_3	IO_L22N_3	T17	I/O
3	IO_L22P_3	IO_L22P_3	U18	I/O
3	IO_L23N_3	IO_L23N_3	U21	I/O
3	IO_L23P_3/VREF_3	IO_L23P_3/VREF_3	U20	VREF
3	IO_L24N_3	IO_L24N_3	R18	I/O
3	IO_L24P_3	IO_L24P_3	T18	I/O
3	N.C. (◆)	IO_L26N_3	T20	I/O
3	N.C. (◆)	IO_L26P_3	T19	I/O
3	IO_L27N_3	IO_L27N_3	T22	I/O
3	IO_L27P_3	IO_L27P_3	T21	I/O
3	N.C. (◆)	IO_L28N_3	R22	I/O
3	N.C. (◆)	IO_L28P_3	R21	I/O
3	N.C. (◆)	IO_L29N_3	P19	I/O
3	N.C. (◆)	IO_L29P_3	R19	I/O
3	N.C. (◆)	IO_L31N_3	P18	I/O
3	N.C. (◆)	IO_L31P_3	P17	I/O
3	N.C. (◆)	IO_L32N_3	P22	I/O
3	N.C. (◆)	IO_L32P_3	P21	I/O
3	N.C. (◆)	IO_L33N_3	N18	I/O
3	N.C. (◆)	IO_L33P_3	N17	I/O
3	IO_L34N_3	IO_L34N_3	N20	I/O
3	IO_L34P_3/VREF_3	IO_L34P_3/VREF_3	N19	VREF
3	IO_L35N_3	IO_L35N_3	N22	I/O
3	IO_L35P_3	IO_L35P_3	N21	I/O
3	IO_L38N_3	IO_L38N_3	M18	I/O
3	IO_L38P_3	IO_L38P_3	M17	I/O
3	IO_L39N_3	IO_L39N_3	M20	I/O
3	IO_L39P_3	IO_L39P_3	M19	I/O
3	IO_L40N_3/VREF_3	IO_L40N_3/VREF_3	M22	VREF
3	IO_L40P_3	IO_L40P_3	M21	I/O
3	VCCO_3	VCCO_3	M16	VCCO

Table 100: FG456 Package Pinout (Cont'd)

Bank	3S400 Pin Name	3S1000, 3S1500, 3S2000 Pin Name	FG456 Pin Number	Type
6	N.C. (◆)	IO_L28N_6	R5	I/O
6	N.C. (◆)	IO_L28P_6	P6	I/O
6	N.C. (◆)	IO_L29N_6	R2	I/O
6	N.C. (◆)	IO_L29P_6	R1	I/O
6	N.C. (◆)	IO_L31N_6	P5	I/O
6	N.C. (◆)	IO_L31P_6	P4	I/O
6	N.C. (◆)	IO_L32N_6	P2	I/O
6	N.C. (◆)	IO_L32P_6	P1	I/O
6	N.C. (◆)	IO_L33N_6	N6	I/O
6	N.C. (◆)	IO_L33P_6	N5	I/O
6	IO_L34N_6/VREF_6	IO_L34N_6/VREF_6	N4	VREF
6	IO_L34P_6	IO_L34P_6	N3	I/O
6	IO_L35N_6	IO_L35N_6	N2	I/O
6	IO_L35P_6	IO_L35P_6	N1	I/O
6	IO_L38N_6	IO_L38N_6	M6	I/O
6	IO_L38P_6	IO_L38P_6	M5	I/O
6	IO_L39N_6	IO_L39N_6	M4	I/O
6	IO_L39P_6	IO_L39P_6	M3	I/O
6	IO_L40N_6	IO_L40N_6	M2	I/O
6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	M1	VREF
6	VCCO_6	VCCO_6	M7	VCCO
6	VCCO_6	VCCO_6	N7	VCCO
6	VCCO_6	VCCO_6	P7	VCCO
6	VCCO_6	VCCO_6	R3	VCCO
6	VCCO_6	VCCO_6	R6	VCCO
7	IO	IO	C2	I/O
7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	C3	DCI
7	IO_L01P_7/VRN_7	IO_L01P_7/VRN_7	C4	DCI
7	IO_L16N_7	IO_L16N_7	D1	I/O
7	IO_L16P_7/VREF_7	IO_L16P_7/VREF_7	C1	VREF
7	IO_L17N_7	IO_L17N_7	E4	I/O
7	IO_L17P_7	IO_L17P_7	D4	I/O
7	IO_L19N_7/VREF_7	IO_L19N_7/VREF_7	D3	VREF
7	IO_L19P_7	IO_L19P_7	D2	I/O
7	IO_L20N_7	IO_L20N_7	F4	I/O
7	IO_L20P_7	IO_L20P_7	E3	I/O
7	IO_L21N_7	IO_L21N_7	E1	I/O
7	IO_L21P_7	IO_L21P_7	E2	I/O
7	IO_L22N_7	IO_L22N_7	G6	I/O
7	IO_L22P_7	IO_L22P_7	F5	I/O

Table 103: FG676 Package Pinout (Cont'd)

Bank	XC3S1000 Pin Name	XC3S1500 Pin Name	XC3S2000 Pin Name	XC3S4000 Pin Name	XC3S5000 Pin Name	FG676 Pin Number	Type
6	IO_L20N_6	IO_L20N_6	IO_L20N_6	IO_L20N_6	IO_L20N_6	V7	I/O
6	IO_L20P_6	IO_L20P_6	IO_L20P_6	IO_L20P_6	IO_L20P_6	U7	I/O
6	IO_L21N_6	IO_L21N_6	IO_L21N_6	IO_L21N_6	IO_L21N_6	V5	I/O
6	IO_L21P_6	IO_L21P_6	IO_L21P_6	IO_L21P_6	IO_L21P_6	V4	I/O
6	IO_L22N_6	IO_L22N_6	IO_L22N_6	IO_L22N_6	IO_L22N_6	V3	I/O
6	IO_L22P_6	IO_L22P_6	IO_L22P_6	IO_L22P_6	IO_L22P_6	V2	I/O
6	IO_L23N_6	IO_L23N_6	IO_L23N_6	IO_L23N_6	IO_L23N_6	U6	I/O
6	IO_L23P_6	IO_L23P_6	IO_L23P_6	IO_L23P_6	IO_L23P_6	U5	I/O
6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	U4	VREF
6	IO_L24P_6	IO_L24P_6	IO_L24P_6	IO_L24P_6	IO_L24P_6	U3	I/O
6	IO_L26N_6	IO_L26N_6	IO_L26N_6	IO_L26N_6	IO_L26N_6	U2	I/O
6	IO_L26P_6	IO_L26P_6	IO_L26P_6	IO_L26P_6	IO_L26P_6	U1	I/O
6	IO_L27N_6	IO_L27N_6	IO_L27N_6	IO_L27N_6	IO_L27N_6	T8	I/O
6	IO_L27P_6	IO_L27P_6	IO_L27P_6	IO_L27P_6	IO_L27P_6	T7	I/O
6	IO_L28N_6	IO_L28N_6	IO_L28N_6	IO_L28N_6	IO_L28N_6	T6	I/O
6	IO_L28P_6	IO_L28P_6	IO_L28P_6	IO_L28P_6	IO_L28P_6	T5	I/O
6	IO_L29N_6	IO_L29N_6	IO_L29N_6	IO_L29N_6	IO_L29N_6	T2	I/O
6	IO_L29P_6	IO_L29P_6	IO_L29P_6	IO_L29P_6	IO_L29P_6	T1	I/O
6	IO_L31N_6	IO_L31N_6	IO_L31N_6	IO_L31N_6	IO_L31N_6	R8	I/O
6	IO_L31P_6	IO_L31P_6	IO_L31P_6	IO_L31P_6	IO_L31P_6	R7	I/O
6	IO_L32N_6	IO_L32N_6	IO_L32N_6	IO_L32N_6	IO_L32N_6	R6	I/O
6	IO_L32P_6	IO_L32P_6	IO_L32P_6	IO_L32P_6	IO_L32P_6	R5	I/O
6	IO_L33N_6	IO_L33N_6	IO_L33N_6	IO_L33N_6	IO_L33N_6	T4	I/O
6	IO_L33P_6	IO_L33P_6	IO_L33P_6	IO_L33P_6	IO_L33P_6	R3	I/O
6	IO_L34N_6/VREF_6	IO_L34N_6/VREF_6	IO_L34N_6/VREF_6	IO_L34N_6/VREF_6	IO_L34N_6/VREF_6	R2	VREF
6	IO_L34P_6	IO_L34P_6	IO_L34P_6	IO_L34P_6	IO_L34P_6	R1	I/O
6	IO_L35N_6	IO_L35N_6	IO_L35N_6	IO_L35N_6	IO_L35N_6	P8	I/O
6	IO_L35P_6	IO_L35P_6	IO_L35P_6	IO_L35P_6	IO_L35P_6	P7	I/O
6	IO_L38N_6	IO_L38N_6	IO_L38N_6	IO_L38N_6	IO_L38N_6	P6	I/O
6	IO_L38P_6	IO_L38P_6	IO_L38P_6	IO_L38P_6	IO_L38P_6	P5	I/O
6	IO_L39N_6	IO_L39N_6	IO_L39N_6	IO_L39N_6	IO_L39N_6	P4	I/O
6	IO_L39P_6	IO_L39P_6	IO_L39P_6	IO_L39P_6	IO_L39P_6	P3	I/O
6	IO_L40N_6	IO_L40N_6	IO_L40N_6	IO_L40N_6	IO_L40N_6	P2	I/O
6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	P1	VREF
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	P9	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	P10	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	R9	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	T3	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	T9	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	U8	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	V8	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	Y3	VCCO
7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	F5	DCI

Table 103: FG676 Package Pinout (Cont'd)

Bank	XC3S1000 Pin Name	XC3S1500 Pin Name	XC3S2000 Pin Name	XC3S4000 Pin Name	XC3S5000 Pin Name	FG676 Pin Number	Type
7	IO_L01P_7/VRN_7	IO_L01P_7/VRN_7	IO_L01P_7/VRN_7	IO_L01P_7/VRN_7	IO_L01P_7/VRN_7	F6	DCI
7	IO_L02N_7	IO_L02N_7	IO_L02N_7	IO_L02N_7	IO_L02N_7	E3	I/O
7	IO_L02P_7	IO_L02P_7	IO_L02P_7	IO_L02P_7	IO_L02P_7	E4	I/O
7	IO_L03N_7/VREF_7	IO_L03N_7/VREF_7	IO_L03N_7/VREF_7	IO_L03N_7/VREF_7	IO_L03N_7/VREF_7	D1	VREF
7	IO_L03P_7	IO_L03P_7	IO_L03P_7	IO_L03P_7	IO_L03P_7	D2	I/O
7	N.C. (◆)	IO_L05N_7	IO_L05N_7	IO_L05N_7	IO_L05N_7	G6	I/O
7	N.C. (◆)	IO_L05P_7	IO_L05P_7	IO_L05P_7	IO_L05P_7	G7	I/O
7	N.C. (◆)	IO_L06N_7	IO_L06N_7	IO_L06N_7	IO_L06N_7	E1	I/O
7	N.C. (◆)	IO_L06P_7	IO_L06P_7	IO_L06P_7	IO_L06P_7	E2	I/O
7	N.C. (◆)	IO_L07N_7	IO_L07N_7	IO_L07N_7	IO_L07N_7	F3	I/O
7	N.C. (◆)	IO_L07P_7	IO_L07P_7	IO_L07P_7	IO_L07P_7	F4	I/O
7	N.C. (◆)	IO_L08N_7	IO_L08N_7	IO_L08N_7	IO_L08N_7	G4	I/O
7	N.C. (◆)	IO_L08P_7	IO_L08P_7	IO_L08P_7	IO_L08P_7	G5	I/O
7	N.C. (◆)	IO_L09N_7	IO_L09N_7	IO_L09N_7	IO_L09N_7	F1	I/O
7	N.C. (◆)	IO_L09P_7	IO_L09P_7	IO_L09P_7	IO_L09P_7	F2	I/O
7	N.C. (◆)	IO_L10N_7	IO_L10N_7	IO_L10N_7	IO_L10N_7	H6	I/O
7	N.C. (◆)	IO_L10P_7/VREF_7	IO_L10P_7/VREF_7	IO_L10P_7/VREF_7	IO_L10P_7/VREF_7	H7	VREF
7	IO_L14N_7	IO_L14N_7	IO_L14N_7	IO_L14N_7	IO_L14N_7	G1	I/O
7	IO_L14P_7	IO_L14P_7	IO_L14P_7	IO_L14P_7	IO_L14P_7	G2	I/O
7	IO_L16N_7	IO_L16N_7	IO_L16N_7	IO_L16N_7	IO_L16N_7	J6	I/O
7	IO_L16P_7/VREF_7	IO_L16P_7/VREF_7	IO_L16P_7/VREF_7	IO_L16P_7/VREF_7	IO_L16P_7/VREF_7	H5	VREF
7	IO_L17N_7	IO_L17N_7	IO_L17N_7	IO_L17N_7	IO_L17N_7	H3	I/O
7	IO_L17P_7	IO_L17P_7	IO_L17P_7	IO_L17P_7	IO_L17P_7	H4	I/O
7	IO_L19N_7/VREF_7	IO_L19N_7/VREF_7	IO_L19N_7/VREF_7	IO_L19N_7/VREF_7	IO_L19N_7/VREF_7	H1	VREF
7	IO_L19P_7	IO_L19P_7	IO_L19P_7	IO_L19P_7	IO_L19P_7	H2	I/O
7	IO_L20N_7	IO_L20N_7	IO_L20N_7	IO_L20N_7	IO_L20N_7	K7	I/O
7	IO_L20P_7	IO_L20P_7	IO_L20P_7	IO_L20P_7	IO_L20P_7	J7	I/O
7	IO_L21N_7	IO_L21N_7	IO_L21N_7	IO_L21N_7	IO_L21N_7	J4	I/O
7	IO_L21P_7	IO_L21P_7	IO_L21P_7	IO_L21P_7	IO_L21P_7	J5	I/O
7	IO_L22N_7	IO_L22N_7	IO_L22N_7	IO_L22N_7	IO_L22N_7	J2	I/O
7	IO_L22P_7	IO_L22P_7	IO_L22P_7	IO_L22P_7	IO_L22P_7	J3	I/O
7	IO_L23N_7	IO_L23N_7	IO_L23N_7	IO_L23N_7	IO_L23N_7	K5	I/O
7	IO_L23P_7	IO_L23P_7	IO_L23P_7	IO_L23P_7	IO_L23P_7	K6	I/O
7	IO_L24N_7	IO_L24N_7	IO_L24N_7	IO_L24N_7	IO_L24N_7	K3	I/O
7	IO_L24P_7	IO_L24P_7	IO_L24P_7	IO_L24P_7	IO_L24P_7	K4	I/O
7	IO_L26N_7	IO_L26N_7	IO_L26N_7	IO_L26N_7	IO_L26N_7	K1	I/O
7	IO_L26P_7	IO_L26P_7	IO_L26P_7	IO_L26P_7	IO_L26P_7	K2	I/O
7	IO_L27N_7	IO_L27N_7	IO_L27N_7	IO_L27N_7	IO_L27N_7	L7	I/O
7	IO_L27P_7/VREF_7	IO_L27P_7/VREF_7	IO_L27P_7/VREF_7	IO_L27P_7/VREF_7	IO_L27P_7/VREF_7	L8	VREF
7	IO_L28N_7	IO_L28N_7	IO_L28N_7	IO_L28N_7	IO_L28N_7	L5	I/O
7	IO_L28P_7	IO_L28P_7	IO_L28P_7	IO_L28P_7	IO_L28P_7	L6	I/O
7	IO_L29N_7	IO_L29N_7	IO_L29N_7	IO_L29N_7	IO_L29N_7	L1	I/O

Table 107: FG900 Package Pinout (Cont'd)

Bank	XC3S2000 Pin Name	XC3S4000, XC3S5000 Pin Name	FG900 Pin Number	Type
1	IO_L05P_1	IO_L05P_1	F25	I/O
1	IO_L06N_1/VREF_1	IO_L06N_1/VREF_1	C24	VREF
1	IO_L06P_1	IO_L06P_1	D24	I/O
1	IO_L07N_1	IO_L07N_1	A24	I/O
1	IO_L07P_1	IO_L07P_1	B24	I/O
1	IO_L08N_1	IO_L08N_1	H23	I/O
1	IO_L08P_1	IO_L08P_1	G24	I/O
1	IO_L09N_1	IO_L09N_1	F23	I/O
1	IO_L09P_1	IO_L09P_1	G23	I/O
1	IO_L10N_1/VREF_1	IO_L10N_1/VREF_1	C23	VREF
1	IO_L10P_1	IO_L10P_1	D23	I/O
1	IO_L11N_1	IO_L11N_1	A23	I/O
1	IO_L11P_1	IO_L11P_1	B23	I/O
1	IO_L12N_1	IO_L12N_1	H22	I/O
1	IO_L12P_1	IO_L12P_1	J22	I/O
1	IO_L13N_1	IO_L13N_1	F22	I/O
1	IO_L13P_1	IO_L13P_1	E23	I/O
1	IO_L14N_1	IO_L14N_1	D22	I/O
1	IO_L14P_1	IO_L14P_1	E22	I/O
1	IO_L15N_1	IO_L15N_1	A22	I/O
1	IO_L15P_1	IO_L15P_1	B22	I/O
1	IO_L16N_1	IO_L16N_1	F21	I/O
1	IO_L16P_1	IO_L16P_1	G21	I/O
1	IO_L17N_1/VREF_1	IO_L17N_1/VREF_1	B21	VREF
1	IO_L17P_1	IO_L17P_1	C21	I/O
1	IO_L18N_1	IO_L18N_1	G20	I/O
1	IO_L18P_1	IO_L18P_1	H20	I/O
1	IO_L19N_1	IO_L19N_1	E20	I/O
1	IO_L19P_1	IO_L19P_1	F20	I/O
1	IO_L20N_1	IO_L20N_1	C20	I/O
1	IO_L20P_1	IO_L20P_1	D20	I/O
1	IO_L21N_1	IO_L21N_1	A20	I/O
1	IO_L21P_1	IO_L21P_1	B20	I/O
1	IO_L22N_1	IO_L22N_1	J19	I/O
1	IO_L22P_1	IO_L22P_1	K19	I/O
1	IO_L23N_1	IO_L23N_1	G19	I/O
1	IO_L23P_1	IO_L23P_1	H19	I/O
1	IO_L24N_1	IO_L24N_1	E19	I/O
1	IO_L24P_1	IO_L24P_1	F19	I/O
1	IO_L25N_1	IO_L25N_1	C19	I/O

Table 107: FG900 Package Pinout (Cont'd)

Bank	XC3S2000 Pin Name	XC3S4000, XC3S5000 Pin Name	FG900 Pin Number	Type
3	N.C. (◆)	IO_L50P_3	V26	I/O
3	VCCO_3	VCCO_3	U20	VCCO
3	VCCO_3	VCCO_3	V20	VCCO
3	VCCO_3	VCCO_3	W20	VCCO
3	VCCO_3	VCCO_3	Y22	VCCO
3	VCCO_3	VCCO_3	V24	VCCO
3	VCCO_3	VCCO_3	AB24	VCCO
3	VCCO_3	VCCO_3	AD26	VCCO
3	VCCO_3	VCCO_3	V28	VCCO
3	VCCO_3	VCCO_3	AB28	VCCO
3	VCCO_3	VCCO_3	AF28	VCCO
4	IO	IO	AA16	I/O
4	IO	IO	AG18	I/O
4	IO	IO	AA18	I/O
4	IO	IO	AE22	I/O
4	IO	IO	AD23	I/O
4	IO	IO	AH27	I/O
4	IO/VREF_4	IO/VREF_4	AF16	VREF
4	IO/VREF_4	IO/VREF_4	AK28	VREF
4	IO_L01N_4/VRP_4	IO_L01N_4/VRP_4	AJ27	DCI
4	IO_L01P_4/VRN_4	IO_L01P_4/VRN_4	AK27	DCI
4	IO_L02N_4	IO_L02N_4	AJ26	I/O
4	IO_L02P_4	IO_L02P_4	AK26	I/O
4	IO_L03N_4	IO_L03N_4	AG26	I/O
4	IO_L03P_4	IO_L03P_4	AF25	I/O
4	IO_L04N_4	IO_L04N_4	AD24	I/O
4	IO_L04P_4	IO_L04P_4	AC23	I/O
4	IO_L05N_4	IO_L05N_4	AE23	I/O
4	IO_L05P_4	IO_L05P_4	AF23	I/O
4	IO_L06N_4/VREF_4	IO_L06N_4/VREF_4	AG23	VREF
4	IO_L06P_4	IO_L06P_4	AH23	I/O
4	IO_L07N_4	IO_L07N_4	AJ23	I/O
4	IO_L07P_4	IO_L07P_4	AK23	I/O
4	IO_L08N_4	IO_L08N_4	AB22	I/O
4	IO_L08P_4	IO_L08P_4	AC22	I/O
4	IO_L09N_4	IO_L09N_4	AF22	I/O
4	IO_L09P_4	IO_L09P_4	AG22	I/O
4	IO_L10N_4	IO_L10N_4	AJ22	I/O
4	IO_L10P_4	IO_L10P_4	AK22	I/O
4	IO_L11N_4	IO_L11N_4	AD21	I/O

Table 107: FG900 Package Pinout (Cont'd)

Bank	XC3S2000 Pin Name	XC3S4000, XC3S5000 Pin Name	FG900 Pin Number	Type
6	IO_L05P_6	IO_L05P_6	AE5	I/O
6	IO_L06N_6	IO_L06N_6	AE3	I/O
6	IO_L06P_6	IO_L06P_6	AE2	I/O
6	IO_L07N_6	IO_L07N_6	AD4	I/O
6	IO_L07P_6	IO_L07P_6	AD3	I/O
6	IO_L08N_6	IO_L08N_6	AD2	I/O
6	IO_L08P_6	IO_L08P_6	AD1	I/O
6	IO_L09N_6/VREF_6	IO_L09N_6/VREF_6	AD6	VREF
6	IO_L09P_6	IO_L09P_6	AC7	I/O
6	IO_L10N_6	IO_L10N_6	AC6	I/O
6	IO_L10P_6	IO_L10P_6	AC5	I/O
6	IO_L11N_6	IO_L11N_6	AC4	I/O
6	IO_L11P_6	IO_L11P_6	AC3	I/O
6	IO_L13N_6	IO_L13N_6	AC2	I/O
6	IO_L13P_6/VREF_6	IO_L13P_6/VREF_6	AC1	VREF
6	IO_L14N_6	IO_L14N_6	AB5	I/O
6	IO_L14P_6	IO_L14P_6	AB4	I/O
6	IO_L15N_6	IO_L15N_6	AB2	I/O
6	IO_L15P_6	IO_L15P_6	AB1	I/O
6	IO_L16N_6	IO_L16N_6	AB8	I/O
6	IO_L16P_6	IO_L16P_6	AA9	I/O
6	IO_L17N_6	IO_L17N_6	AA7	I/O
6	IO_L17P_6/VREF_6	IO_L17P_6/VREF_6	AA6	VREF
6	IO_L19N_6	IO_L19N_6	AA3	I/O
6	IO_L19P_6	IO_L19P_6	AA2	I/O
6	IO_L20N_6	IO_L20N_6	AA10	I/O
6	IO_L20P_6	IO_L20P_6	Y10	I/O
6	IO_L21N_6	IO_L21N_6	Y8	I/O
6	IO_L21P_6	IO_L21P_6	Y7	I/O
6	IO_L22N_6	IO_L22N_6	Y6	I/O
6	IO_L22P_6	IO_L22P_6	Y5	I/O
6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	Y2	VREF
6	IO_L24P_6	IO_L24P_6	Y1	I/O
6	N.C. (◆)	IO_L25N_6	W9	I/O
6	N.C. (◆)	IO_L25P_6	W8	I/O
6	IO_L26N_6	IO_L26N_6	W7	I/O
6	IO_L26P_6	IO_L26P_6	W6	I/O
6	IO_L27N_6	IO_L27N_6	W4	I/O
6	IO_L27P_6	IO_L27P_6	W3	I/O
6	IO_L28N_6	IO_L28N_6	W2	I/O

Table 107: FG900 Package Pinout (Cont'd)

Bank	XC3S2000 Pin Name	XC3S4000, XC3S5000 Pin Name	FG900 Pin Number	Type
7	IO_L23N_7	IO_L23N_7	L3	I/O
7	IO_L23P_7	IO_L23P_7	L4	I/O
7	IO_L24N_7	IO_L24N_7	L1	I/O
7	IO_L24P_7	IO_L24P_7	L2	I/O
7	N.C. (◆)	IO_L25N_7	M6	I/O
7	N.C. (◆)	IO_L25P_7	M7	I/O
7	IO_L26N_7	IO_L26N_7	M3	I/O
7	IO_L26P_7	IO_L26P_7	M4	I/O
7	IO_L27N_7	IO_L27N_7	M1	I/O
7	IO_L27P_7/VREF_7	IO_L27P_7/VREF_7	M2	VREF
7	IO_L28N_7	IO_L28N_7	N10	I/O
7	IO_L28P_7	IO_L28P_7	M10	I/O
7	IO_L29N_7	IO_L29N_7	N8	I/O
7	IO_L29P_7	IO_L29P_7	N9	I/O
7	IO_L31N_7	IO_L31N_7	N1	I/O
7	IO_L31P_7	IO_L31P_7	N2	I/O
7	IO_L32N_7	IO_L32N_7	P9	I/O
7	IO_L32P_7	IO_L32P_7	P10	I/O
7	IO_L33N_7	IO_L33N_7	P6	I/O
7	IO_L33P_7	IO_L33P_7	P7	I/O
7	IO_L34N_7	IO_L34N_7	P2	I/O
7	IO_L34P_7	IO_L34P_7	P3	I/O
7	IO_L35N_7	IO_L35N_7	R9	I/O
7	IO_L35P_7	IO_L35P_7	R10	I/O
7	IO_L37N_7	IO_L37N_7	R7	I/O
7	IO_L37P_7/VREF_7	IO_L37P_7/VREF_7	R8	VREF
7	IO_L38N_7	IO_L38N_7	R5	I/O
7	IO_L38P_7	IO_L38P_7	R6	I/O
7	IO_L39N_7	IO_L39N_7	R3	I/O
7	IO_L39P_7	IO_L39P_7	R4	I/O
7	IO_L40N_7/VREF_7	IO_L40N_7/VREF_7	R1	VREF
7	IO_L40P_7	IO_L40P_7	R2	I/O
7	N.C. (◆)	IO_L46N_7	M8	I/O
7	N.C. (◆)	IO_L46P_7	M9	I/O
7	N.C. (◆)	IO_L49N_7	N6	I/O
7	N.C. (◆)	IO_L49P_7	M5	I/O
7	N.C. (◆)	IO_L50N_7	N4	I/O
7	N.C. (◆)	IO_L50P_7	N5	I/O
7	VCCO_7	VCCO_7	E3	VCCO
7	VCCO_7	VCCO_7	J3	VCCO

Table 110: FG1156 Package Pinout (Cont'd)

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
2	IO_L19N_2	IO_L19N_2	M29	I/O
2	IO_L19P_2	IO_L19P_2	M30	I/O
2	IO_L20N_2	IO_L20N_2	M31	I/O
2	IO_L20P_2	IO_L20P_2	M32	I/O
2	IO_L21N_2	IO_L21N_2	M26	I/O
2	IO_L21P_2	IO_L21P_2	N25	I/O
2	IO_L22N_2	IO_L22N_2	N27	I/O
2	IO_L22P_2	IO_L22P_2	N28	I/O
2	IO_L23N_2/VREF_2	IO_L23N_2/VREF_2	N31	VREF
2	IO_L23P_2	IO_L23P_2	N32	I/O
2	IO_L24N_2	IO_L24N_2	N24	I/O
2	IO_L24P_2	IO_L24P_2	P24	I/O
2	IO_L26N_2	IO_L26N_2	P29	I/O
2	IO_L26P_2	IO_L26P_2	P30	I/O
2	IO_L27N_2	IO_L27N_2	P31	I/O
2	IO_L27P_2	IO_L27P_2	P32	I/O
2	IO_L28N_2	IO_L28N_2	P33	I/O
2	IO_L28P_2	IO_L28P_2	P34	I/O
2	IO_L29N_2	IO_L29N_2	R24	I/O
2	IO_L29P_2	IO_L29P_2	R25	I/O
2	IO_L30N_2	IO_L30N_2	R28	I/O
2	IO_L30P_2	IO_L30P_2	R29	I/O
2	IO_L31N_2	IO_L31N_2	R31	I/O
2	IO_L31P_2	IO_L31P_2	R32	I/O
2	IO_L32N_2	IO_L32N_2	R33	I/O
2	IO_L32P_2	IO_L32P_2	R34	I/O
2	IO_L33N_2	IO_L33N_2	R26	I/O
2	IO_L33P_2	IO_L33P_2	T25	I/O
2	IO_L34N_2/VREF_2	IO_L34N_2/VREF_2	T28	VREF
2	IO_L34P_2	IO_L34P_2	T29	I/O
2	IO_L35N_2	IO_L35N_2	T32	I/O
2	IO_L35P_2	IO_L35P_2	T33	I/O
2	IO_L37N_2	IO_L37N_2	U27	I/O
2	IO_L37P_2	IO_L37P_2	U28	I/O
2	IO_L38N_2	IO_L38N_2	U29	I/O
2	IO_L38P_2	IO_L38P_2	U30	I/O
2	IO_L39N_2	IO_L39N_2	U31	I/O
2	IO_L39P_2	IO_L39P_2	U32	I/O
2	IO_L40N_2	IO_L40N_2	U33	I/O
2	IO_L40P_2/VREF_2	IO_L40P_2/VREF_2	U34	VREF

Table 110: FG1156 Package Pinout (Cont'd)

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
3	IO_L48P_3	IO_L48P_3	AB24	I/O
3	N.C. (◆)	IO_L49N_3	AA26	I/O
3	N.C. (◆)	IO_L49P_3	AA25	I/O
3	IO_L50N_3	IO_L50N_3	Y25	I/O
3	IO_L50P_3	IO_L50P_3	Y24	I/O
3	N.C. (◆)	IO_L51N_3	V24	I/O
3	N.C. (◆)	IO_L51P_3	W24	I/O
3	VCCO_3	VCCO_3	AA23	VCCO
3	VCCO_3	VCCO_3	AB23	VCCO
3	VCCO_3	VCCO_3	AB29	VCCO
3	VCCO_3	VCCO_3	AB33	VCCO
3	VCCO_3	VCCO_3	AD27	VCCO
3	VCCO_3	VCCO_3	AD31	VCCO
3	VCCO_3	VCCO_3	AG28	VCCO
3	VCCO_3	VCCO_3	AG32	VCCO
3	VCCO_3	VCCO_3	AL32	VCCO
3	VCCO_3	VCCO_3	W23	VCCO
3	VCCO_3	VCCO_3	W31	VCCO
3	VCCO_3	VCCO_3	Y23	VCCO
3	VCCO_3	VCCO_3	Y27	VCCO
4	IO	IO	AD18	I/O
4	IO	IO	AD19	I/O
4	IO	IO	AD20	I/O
4	IO	IO	AD22	I/O
4	IO	IO	AE18	I/O
4	IO	IO	AE19	I/O
4	IO	IO	AE22	I/O
4	N.C. (◆)	IO	AE24	I/O
4	IO	IO	AF24	I/O
4	N.C. (◆)	IO	AF26	I/O
4	IO	IO	AG26	I/O
4	IO	IO	AG27	I/O
4	IO	IO	AJ27	I/O
4	IO	IO	AJ29	I/O
4	IO	IO	AK25	I/O
4	IO	IO	AN26	I/O
4	IO/VREF_4	IO/VREF_4	AF21	VREF
4	IO/VREF_4	IO/VREF_4	AH23	VREF
4	IO/VREF_4	IO/VREF_4	AK18	VREF
4	IO/VREF_4	IO/VREF_4	AL30	VREF

FG1156 Footprint

Top Left Corner of FG1156
Package (Top View)XC3S4000
(712 max. user I/O)621 I/O: Unrestricted,
general-purpose user I/O55 VREF: User I/O or input voltage
reference for bank73 N.C.: Unconnected pins for
XC3S4000 (◆)XC3S5000
(784 max. user I/O)692 I/O: Unrestricted,
general-purpose user I/O56 VREF: User I/O or input voltage
reference for bank1 N.C.: Unconnected pins for
XC3S5000 (■)

Bank 0

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17
A	GND	GND	I/O L01P_0 VRN_0	I/O L02P_0	GND	I/O L05P_0 VREF_0 ◆	I/O L34P_0 ◆	I/O L36P_0	GND	I/O L38P_0	I/O L40P_0 ◆	I/O L15P_0	GND	I/O L22P_0	I/O L26P_0 VREF_0	GND	I/O L32P_0 GCLK6
B	GND	GND	I/O L01N_0 VRP_0	I/O L02N_0	I/O L03P_0	I/O L05N_0	I/O L34N_0 ◆	I/O L36N_0	I/O	I/O L38N_0	I/O L40N_0 ◆	I/O L15N_0	VCCO_0	I/O L22N_0	I/O L26N_0	I/O L28P_0	I/O L32N_0 GCLK7
C	I/O L01N_7 VRP_7	I/O L01P_7 VRN_7	GND	VCCO_0	I/O L03N_0	I/O L04P_0	I/O L33P_0 ◆	VCCO_0	I/O L08P_0	I/O L37P_0	GND	I/O L14P_0	I/O L17P_0	I/O L21P_0	I/O L25P_0	I/O L28N_0	I/O L31P_0 VREF_0
D	I/O L02N_7	I/O L02P_7	VCCO_7	PROG_B	IO VREF_0	I/O L04N_0	I/O L33N_0 ◆	I/O L35P_0	I/O L08N_0	I/O L37N_0	VCCO_0	I/O L14N_0	I/O L17N_0	I/O L21N_0	I/O L25N_0	VCCO_0	I/O L31N_0
E	GND	I/O L03N_7 VREF_7	I/O L03P_7	TDI	GND	VCCAUX	I/O L06P_0	I/O L35N_0	GND	I/O VREF_0	VCCAUX	I/O L13P_0	GND	I/O L20P_0	VCCAUX	GND	I/O
F	I/O L05N_7	I/O L05P_7	I/O L04N_7	I/O L04P_7	VCCAUX	I/O	I/O L06N_0	I/O	I/O L07P_0	I/O L10P_0	I/O L39P_0 ◆	I/O L13N_0	VCCO_0	I/O L20N_0	I/O L24P_0	I/O L27P_0	I/O L30P_0
G	I/O	I/O	I/O L41N_7 ◆	I/O L41P_7 ◆	I/O L06N_7	I/O L06P_7	GND	VCCO_0	I/O L07N_0	I/O L10N_0	I/O L39N_0 ◆	I/O	I/O L16P_0	I/O L19P_0	I/O L24N_0	I/O L27N_0	I/O L30N_0
H	I/O L08N_7	I/O L08P_7	VCCO_7	IO L10P_7 VREF_7	I/O L07N_7	I/O L07P_7	VCCO_7	I/O	I/O L09P_0	VCCO_0	I/O L12P_0	I/O L16N_0	I/O L19N_0	VCCO_0	VCCAUX	I/O L29P_0	
J	GND	I/O L11N_7	I/O L11P_7	I/O L10N_7	GND	I/O L09N_7	I/O L09P_7	I/O L12P_7	I/O ◆	I/O L09N_0	I/O	I/O L12N_0	GND	IO VREF_0	I/O L23P_0	GND	I/O L29N_0
K	I/O L16N_7	I/O L16P_7 VREF_7	I/O L15N_7	I/O L15P_7	I/O L14N_7	I/O L14P_7	I/O L13N_7	I/O L13P_7	I/O L12N_7	GND	I/O ◆	I/O L11P_0	I/O	I/O L18P_0	I/O L23N_0	I/O	I/O
L	IO L19N_7 VREF_7	I/O L19P_7	GND	VCCO_7	VCCAUX	I/O L44N_7 ◆	I/O L44P_7 ◆	VCCO_7	I/O L17N_7	I/O L17P_7	HSWAP_EN	I/O L11N_0	I/O	I/O L18N_0	IO VREF_0	I/O	I/O
M	I/O L45N_7	I/O L45P_7	I/O L23N_7	I/O L23P_7	I/O L22N_7	I/O L22P_7	I/O L21N_7	I/O L21P_7	I/O L24P_7	I/O L20N_7	I/O L20P_7	VCCINT	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCINT
N	GND	VCCO_7	I/O L25N_7	I/O L25P_7	GND	VCCO_7	I/O L46N_7	I/O L46P_7	GND	I/O L24N_7	I/O L26P_7	VCCO_7	VCCINT	VCCINT	VCCINT	VCCINT	GND
P	I/O L49N_7	I/O L49P_7	I/O L29N_7	I/O L29P_7	I/O L28N_7	I/O L28P_7	I/O L27N_7	I/O L27P_7 VREF_7	I/O L47N_7 ◆	I/O L47P_7 ◆	I/O L26N_7	VCCO_7	VCCINT	GND	GND	GND	GND
R	I/O L32N_7	I/O L32P_7	I/O L31N_7	I/O L31P_7	VCCAUX	I/O L30N_7	I/O L30P_7	VCCO_7	I/O L33P_7	I/O L50N_7	I/O L50P_7	VCCO_7	VCCINT	GND	GND	GND	GND
T	GND	I/O L35N_7	I/O L35P_7	VCCO_7	GND	I/O L34N_7	I/O L34P_7	VCCAUX	GND	I/O L33N_7	I/O L51P_7 ◆	VCCO_7	VCCINT	GND	GND	GND	GND
U	IO L40N_7 VREF_7	I/O L40P_7	I/O L39N_7	I/O L39P_7	I/O L38N_7	I/O L38P_7	I/O L37N_7	IO L37P_7 VREF_7	I/O	I/O L51N_7 ◆	VCCINT	GND	GND	GND	GND	GND	

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Figure 57: FG1156 Package Footprint (Top View)

Date	Version	Description
11/30/07	2.3	Added XC3S5000 FG(G)676 package. Noted that the FG(G)1156 package is being discontinued. Updated Table 86 with latest thermal characteristics data.
06/25/08	2.4	Updated formatting and links.
12/04/09	2.5	Added link to UG332 in CCLK: Configuration Clock . Noted that the CP132, CPG132, FG1156, and FGG1156 packages are being discontinued in Table 81 , Table 83 , Table 84 , Table 85 , and Table 86 . Updated CP132: 132-Ball Chip-Scale Package to indicate that the CP132 and CPG132 packages are being discontinued.
10/29/12	3.0	Added Notice of Disclaimer . Per XCN07022 , updated the FG1156 and FGG1156 package discussion throughout document including in Table 81 , Table 83 , Table 84 , Table 85 , and Table 86 . Per XCN08011 , updated CP132 and CPG132 package discussion throughout document including in Table 81 , Table 83 , Table 84 , Table 85 , and Table 86 . This product is not recommended for new designs.

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